

Filterless High Efficiency Class-D Stereo Audio Amplifier

SSM2302

FEATURES

Filterless Class-D amplifier with built-in output stage 1.4 W into 8 Ω at 5.0 V supply with less than 1% THD 85% efficiency at 5.0 V, 1.4 W into 8 Ω speaker Better than 98 dB SNR (signal-to-noise ratio) Single-supply operation from 2.5 V to 5.0 V 20 nA ultralow shutdown current Short-circuit and thermal protection Available in 16-lead, 3 mm \times 3 mm LFCSP Pop-and-click suppression Built-in resistors reduce board component count Fixed and user-adjustable gain configurations

APPLICATIONS

Mobile phones MP3 players Portable gaming Portable electronics Educational toys 勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

GENERAL DESCRIPTION

The SSM2302 is a fully integrated, high efficiency, Class-D stereo audio amplifier. It is designed to maximize performance for mobile phone applications. The application circuit requires a minimum of external components and operates from a single 2.5 V to 5.0 V supply. It is capable of delivering 1.4 W of continuous output power with less than 1% THD + N driving an 8 Ω load from a 5.0 V supply.

The SSM2302 features a high efficiency, low noise modulation scheme. It operates with 85% efficiency at 1.4 W into 8 Ω from a

5.0 V supply and has a signal-to-noise ratio (SNR) that is better than 98 dB. PDM modulation is used to provide lower EMI-radiated emissions compared with other Class-D architectures.

The SSM2302 has a micropower shutdown mode with a typical shutdown current of 20 nA. Shutdown is enabled by applying a logic low to the SD pin.

The architecture of the device allows it to achieve a very low level of pop and click. This minimizes voltage glitches at the output during turn-on and turn-off, thus reducing audible noise on activation and deactivation.

The fully differential input of the SSM2302 provides excellent rejection of common-mode noise on the input. Input coupling capacitors can be omitted if the dc input common-mode voltage is approximately $V_{\rm DD}/2$.

The SSM2302 also has excellent rejection of power supply noise, including noise caused by GSM transmission bursts and RF rectification. PSRR is typically 63 dB at 217 Hz.

The gain can be set to 6 dB or 12 dB utilizing the gain control select pin connected respectively to ground or $V_{\rm DD}$. Gain can also be adjusted externally by using an external resistor.

The SSM2302 is specified over the commercial temperature range $(-40^{\circ}\text{C to } +85^{\circ}\text{C})$. It has built-in thermal shutdown and output short-circuit protection. It is available in a 16-lead, 3 mm \times 3 mm lead-frame chip scale package (LFCSP).

FUNCTIONAL BLOCK DIAGRAM

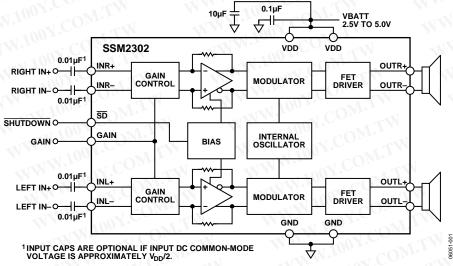


Figure 1.

Rev. 0
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SPECIFICATIONS

Table 1.

able 1.	Symbol	Conditions	Min	Тур	Max	Unit
DEVICE CHARACTERISTICS	Symbol	CONTRACTOR OF CO	N	1717	Mux	-
Output Power	Po	$R_L = 8 \Omega$, THD = 1%, f = 1 kHz, 20 kHz BW, $V_{DD} = 5.0 \text{ V}$	- 1	1.4		w
Output I ower	1007.0	$R_L = 8 \Omega$, THD = 1%, f = 1 kHz, 20 kHz BW, $V_{DD} = 3.6 \text{ V}$. 111	0.615		W
	. V.C	$R_L = 8 \Omega$, THD = 1%, f = 1 kHz, 20 kHz BW, $V_{DD} = 2.5 \text{ V}$	W	0.275		W
	N.100	$R_L = 8 \Omega$, THD = 10%, f = 1 kHz, 20 kHz BW, $V_{DD} = 5.0 \text{ V}$. 1	1.53		W
	-1100X	$R_L = 8 \Omega$, THD = 10%, f = 1 kHz, 20 kHz BW, $V_{DD} = 3.6 \text{ V}$	1.1.	0.77		W
	W. J.	$R_L = 8 \Omega$, THD = 10%, $f = 1 \text{ kHz}$, 20 kHz BW, $V_{DD} = 2.5 \text{ V}$		0.35		W
Efficiency	n l	$P_{OUT} = 1.4 \text{ W}, 8 \Omega, V_{DD} = 5.0 \text{ V}$	Mr	85		%
100 F.C. T.N.	100	1 001 11 11 1 1 1 1 1 1 1 1 1 1 1 1 1 1	·Mo)		,,,
Total Harmonic Distortion + Noise	THD + N	$P_O = 1 \text{ W}$ into 8Ω each channel, $f = 1 \text{ kHz}$, $V_{DD} = 5.0 \text{ V}$	- 11/	0.1		%
N.To.		$P_0 = 0.5$ W into 8 Ω each channel, $f = 1$ kHz, $V_{DD} = 3.6$ V	20_{M_1}	0.04		%
Innut Common Mada Valtaga Panga	V _{CM}	1 0 - 0.5 W III 0 012 Each Chainlei, 1 - 1 Ki iz, V _{DD} - 5.0 V	1.0	0.04	√V _{DD} – 1	V
Input Common-Mode Voltage Range Common-Mode Rejection Ratio	CMRR _{GSM}	$V_{CM} = 2.5 \text{ V} \pm 100 \text{ mV}$ at 217 Hz	1.0	55	V _{DD} — I	dB
Channel Separation	XTALK	$V_{CM} = 2.5 \text{ V} \pm 100 \text{ mV at } 217 \text{ Hz}$ $P_{O} = 100 \text{ mW}, f = 1 \text{ kHz}$	V.CC	98		dВ
Average Switching Frequency	fsw	F0 = 100 IIIW, I = 1 KHZ	-1 (1.8		MHz
Differential Output Offset Voltage	Voos	G = 6 dB; G = 12 dB	01.0	2.0		mV
POWER SUPPLY	VOOS	G = 0 dB, G = 12 dB	MY.	2.0	771	IIIV
Supply Voltage Range	V_{DD}	Guaranteed from PSRR test	25<		F 0	V
Power Supply Rejection Ratio	PSRR	$V_{DD} = 2.5 \text{ V to } 5.0 \text{ V}, 50 \text{ Hz}, \text{ input floating/ground}$	2.5 70	85	5.0	dB
rower supply rejection ratio	PSRR _{GSM}	V _{RIPPLE} = 100 mV at 217 Hz, input noating/ground	400	63		dB
	PSKKGSM	$V_{RIPPLE} = 100 \text{ mV at 217 Hz, inputs ac GND,}$ $C_{IN} = 0.01 \mu\text{F, input referred}$	The	63		ав
Supply Current	I _{SY}	$V_{IN} = 0 \text{ V}$, no load, $V_{DD} = 5.0 \text{ V}$	xi 10	8.0		mA
Supply Current	131	$V_{IN} = 0$ V, no load, $V_{DD} = 3.6$ V	1	6.6		mA
	T	$V_{IN} = 0$ V, no load, $V_{DD} = 3.5$ V	111.	5.3		mA
Shutdown Current	I _{SD}	$\frac{\sqrt{N}}{SD} = \frac{\sqrt{N}}{SD} = $		20		nA
GAIN CONTROL	130	35 - GIVD		1100	- 1	
Closed-Loop Gain	Av0	GAIN pin = 0 V		6		dB
Closed-Loop dain	Av1	GAIN pin = V _{DD}		12		dB
Differential Input Impedance	Zin	$\frac{dAIN pill - VDD}{SD = VDD,}$	MAN	150		ΚΩ
Differential input impedance	ZIN	$\frac{3D}{SD} = VDD,$ $\frac{3D}{SD} = GND$		210		ΚΩ
CLULTDOWAL CONTROL	W.T.V	2D = GND	"	210	<u> </u>	N12
SHUTDOWN CONTROL	W TY	WW 100Y.Cont.Th		120		TIMO
Input Voltage High	VIH	$l_{SY} \ge 1 \text{ mA}$	4	1.2		V
Input Voltage Low	VIL	$I_{SY} \le 300 \text{ nA}$		0.5		COMP.
Turn-On Time	twu	SD rising edge from GND to V _{DD}		30		ms
Turn-Off Time	t _{SD}	SD falling edge from V _{DD} to GND		5		μs
Output Impedance	Z _{out}	$\overline{SD} = GND$		>100	MM.In	ΚΩ
NOISE PERFORMANCE	N.C.	TIM WILLIAM				0.7
Output Voltage Noise	e _n	$V_{DD} = 2.5 \text{ V}$ to 5.0 V, $f = 20 \text{ Hz}$ to 20 kHz, inputs are	V	35		μV
W.I.	00 >	ac grounded, sine wave, $A_V = 6$ dB, A weighting	c N			Lav.C
Signal-to-Noise Ratio	SNR	$P_{OUT} = 1.4 \text{ W}, R_L = 8 \Omega$		98	N. T.	dB

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ABSOLUTE MAXIMUM RATINGS

Absolute maximum ratings apply at 25°C, unless otherwise noted.

Table 2.

Parameter	Rating
Supply Voltage	6V
Input Voltage	V _{DD}
Common-Mode Input Voltage	e V _{DD}
Storage Temperature Range	−65°C to +150°C
Operating Temperature Range	e -40°C to +85°C
Junction Temperature Range	−65°C to +165°C
Lead Temperature Range (Soldering, 60 sec)	300°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL RESISTANCE

 θ_{JA} is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages.

Table 3. Thermal Resistance

Package Type	Ө ЈА	θις	Unit
16-lead, 3 mm × 3 mm LFCSP	44	31.5	°C/W

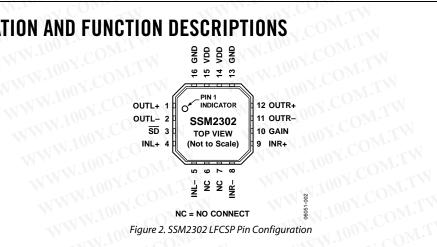
ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



PIN CONFIGURATION AND FUNCTION DESCRIPTIONS WWW.100Y.COM

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Table 4. Pin F	unction Descriptions	WWW. 100Y. COLITY
Pin No.	Mnemonic	Description
1 100 Y	OUTL+	Inverting Output for Left Channel.
2	OUTL-	Noninverting Output for Left Channel.
3	\overline{SD}	Shutdown Input. Active low digital input.
4	INL+	Noninverting Input for Left Channel.
5	INL-	Inverting Input for Left Channel.
6	NC	No Connect.
7 10	NC	No Connect.
8	INR-	Inverting Input for Right Channel.
9	INR+	Noninverting Input for Right Channel.
10	GAIN	Gain Selection. Digital input.
11	OUTR-	Noninverting Output for Right Channel.
12	OUTR+	Inverting Output for Right Channel.
13	GND	Ground for Output Amplifiers.
14	VDD	Power Supply for Output Amplifiers.
15	VDD	Power Supply for Output Amplifiers.
16	GND	Ground for Output Amplifiers.

TYPICAL PERFORMANCE CHARACTERISTICS

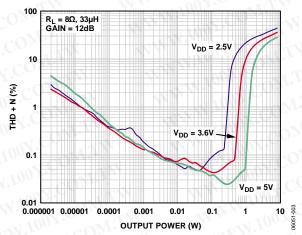
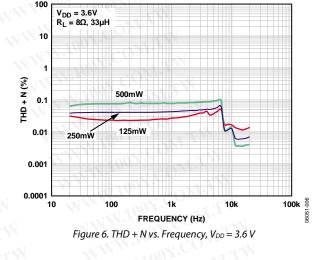


Figure 3. THD + N vs. Output Power into 8 Ω , $A_V = 12 \, dB$



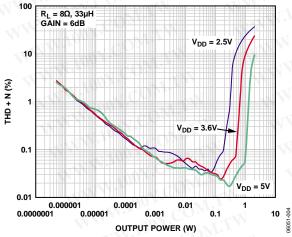


Figure 4. THD + N vs. Output Power into 8 Ω , $A_V = 6 dB$

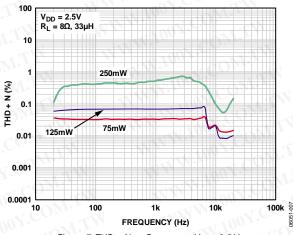


Figure 7. THD + N vs. Frequency, $V_{DD} = 2.5 \text{ V}$

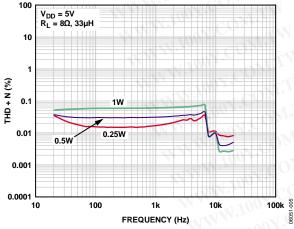


Figure 5. THD + N vs. Frequency, $V_{DD} = 5.0 \text{ V}$

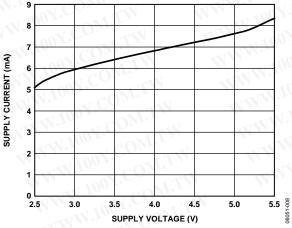


Figure 8. Supply Current vs. Supply Voltage, No Load

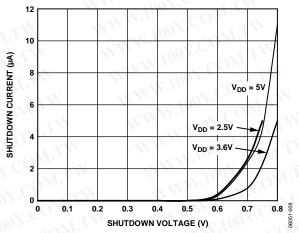
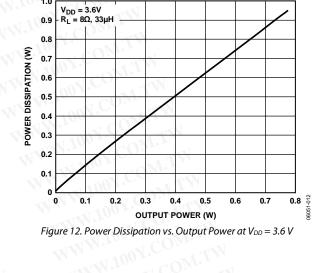


Figure 9. Supply Current vs. Shutdown Voltage



1.0

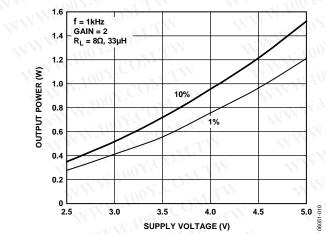


Figure 10. Maximum Output Power vs. Supply Voltage

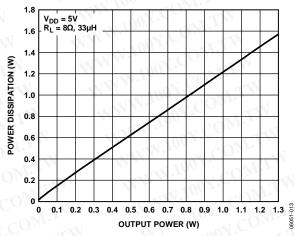


Figure 13. Power Dissipation vs. Output Power at $V_{DD} = 5.0 \text{ V}$

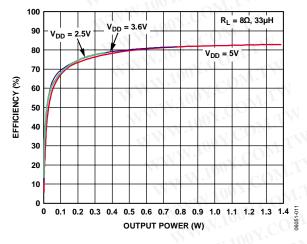


Figure 11. Efficiency vs. Output Power into 8 Ω

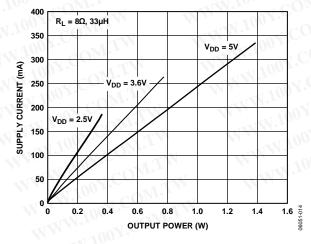


Figure 14. Output Power vs. Supply Current, One Channel

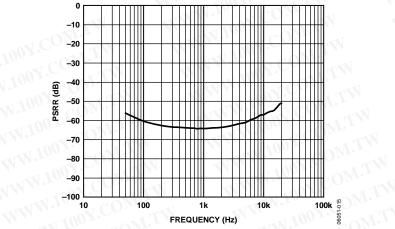
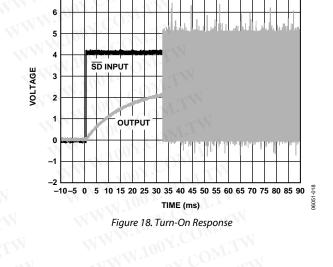


Figure 15. Power Supply Rejection Ratio vs. Frequency



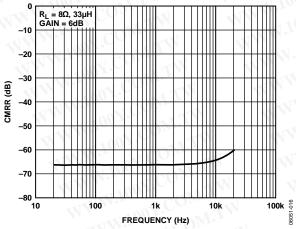
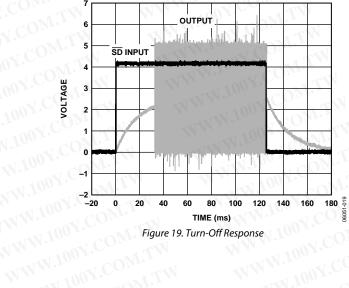


Figure 16. Common-Mode Rejection Ratio vs. Frequency



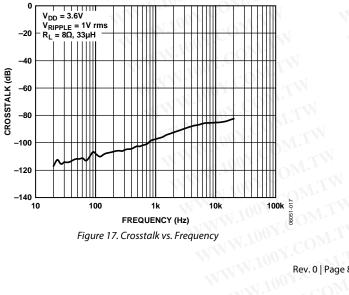


Figure 17. Crosstalk vs. Frequency

TYPICAL APPLICATION CIRCUITS

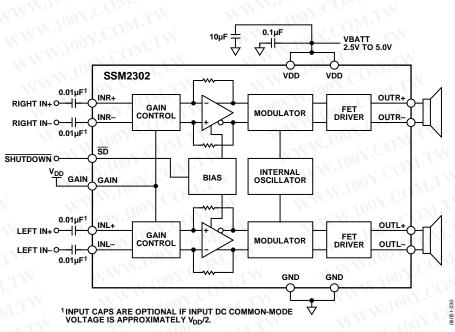


Figure 20. Stereo Differential Input Configuration, Gain = 12 dB

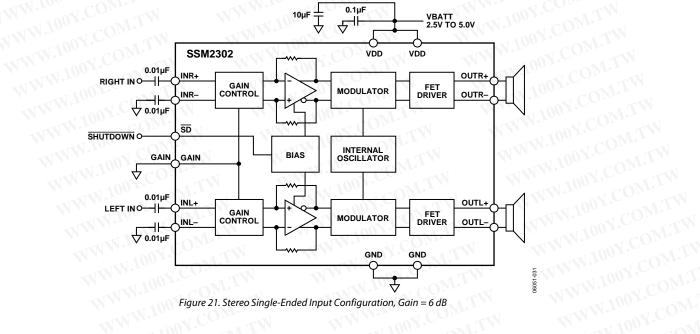


Figure 21. Stereo Single-Ended Input Configuration, Gain = 6 dB

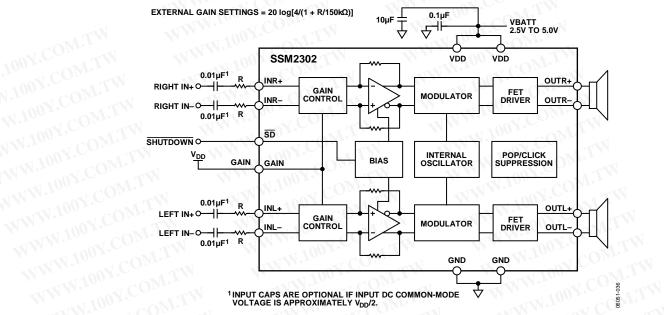


Figure 22. Stereo Differential Input Configuration, User-Adjustable Gain

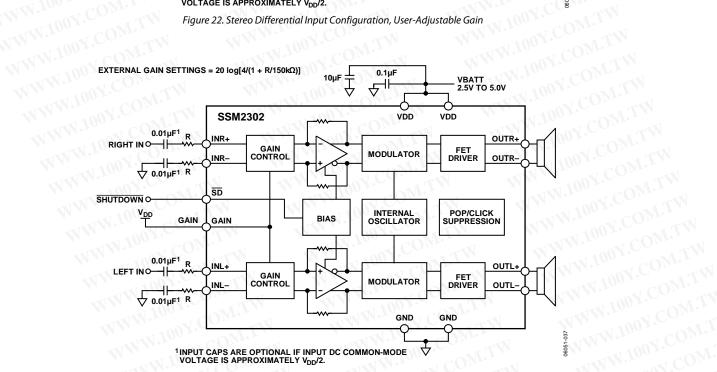


Figure 23. Stereo Single-Ended Input Configuration, User-Adjustable Gain WWW.100Y.COM.TW

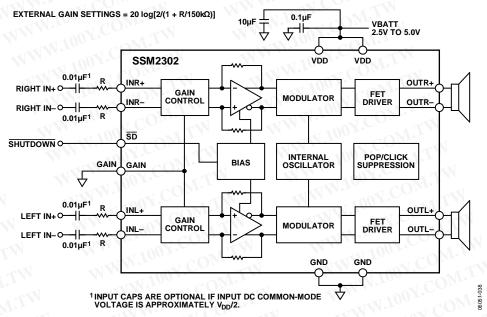
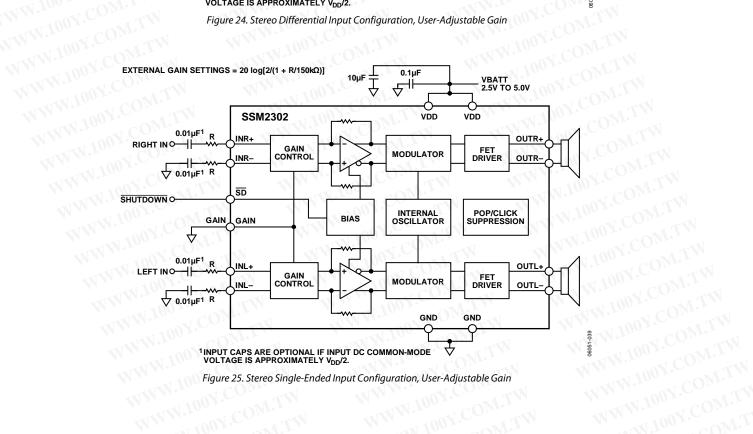


Figure 24. Stereo Differential Input Configuration, User-Adjustable Gain



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APPLICATION NOTES

OVERVIEW

The SSM2302 stereo Class-D audio amplifier features a filterless modulation scheme that greatly reduces the external components count, conserving board space and thus reducing systems cost. The SSM2302 does not require an output filter, but instead relies on the inherent inductance of the speaker coil and the natural filtering of the speaker and human ear to fully recover the audio component of the square-wave output. While most Class-D amplifiers use some variation of pulse-width modulation (PWM), the SSM2302 uses a Σ - Δ modulation to determine the switching pattern of the output devices. This provides a number of important benefits. Σ - Δ modulators do not produces a sharp peak with many harmonics in the AM frequency band, as pulse-width modulators often do. Σ - Δ modulation provides the benefits of reducing the amplitude of spectral components at high frequencies; that is, reducing EMI emission that might otherwise be radiated by speakers and long cable traces. The SSM2302 also offers protection circuits for overcurrent and temperature protection.

GAIN SELECTION

Pulling the GAIN pin high of the SSM2302 sets the gain of the speaker amplifier to 12 dB; pulling it low sets the gain of the speaker amplifier to 6 dB.

It is possible to adjust the SSM2302 gain by using external resistors at the input. To set a gain lower than 12 dB refer to Figure 22 for differential input configuration and Figure 23 for single-ended configuration. For external gain configuration from a fixed 12 dB gain, please use the following formula:

External Gain Settings = $20 \log[4/(1 + R/150 k\Omega)]$

To set a gain lower than 6 dB refer to Figure 24 for differential input configuration and Figure 25 for single-ended configuration. For external gain configuration from a fixed 6 dB gain, use the following formula:

External Gain Settings = $20 \log[2/(1 + R/150 k\Omega)]$

POP-AND-CLICK SUPPRESSION

Voltage transients at the output of audio amplifiers can occur when shutdown is activated or deactivated. Voltage transients as low as 10 mV can be heard as an audio pop in the speaker. Clicks and pops can also be classified as undesirable audible transients generated by the amplifier system, therefore as not coming from the system input signal. Such transients can be generated when the amplifier system changes its operating mode. For example, the following can be sources of audible transients: system power-up/power-down, mute/unmute, input source change, and sample rate change. The SSM2302 has a pop-and-click suppression architecture that reduces this output transients, resulting in noiseless activation and deactivation.

EMI NOISE

The SSM2302 uses a proprietary modulation and spread-spectrum technology to minimize EMI emissions from the device. Figure 26 shows SSM2302 EMI emission starting from 100 kHz to 30 MHz. Figure 27 shows SSM2302 EMI emission from 30 kHz to 2 GHz. These figures clearly describe the SSM2302 EMI behavior as being well below the FCC regulation values, starting from 100 kHz and passing beyond 1 GHz of frequency. Although the overall EMI noise floor is slightly higher, frequency spurs from the SSM2302 are greatly reduced.

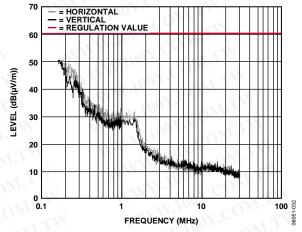


Figure 26. EMI Emissions from SSM2302

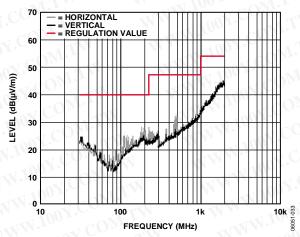


Figure 27. EMI Emissions from SSM2302

The measurements for Figure 26 and Figure 27 were taken with a 1 kHz input signal, producing 0.5 W output power into an 8 Ω load from a 3.6 V supply. Cable length was approximately 5 cm. The EMI was detected using a magnetic probe touching the 2" output trace to the load.

LAYOUT

As output power continues to increase, care needs to be taken to lay out PCB traces and wires properly between the amplifier, load, and power supply. A good practice is to use short, wide PCB tracks to decrease voltage drops and minimize inductance. Make track widths at least 200 mil for every inch of track length for lowest DCR, and use 1 oz or 2 oz of copper PCB traces to further reduce IR drops and inductance. A poor layout increases voltage drops, consequently affecting efficiency. Use large traces for the power supply inputs and amplifier outputs to minimize losses due to parasitic trace resistance. Proper grounding guidelines helps to improve audio performance, minimize crosstalk between channels, and prevent switching noise from coupling into the audio signal. To maintain high output swing and high peak output power, the PCB traces that connect the output pins to the load and supply pins should be as wide as possible to maintain the minimum trace resistances. It is also recommended to use a large-area ground plane for minimum impedances. Good PCB layouts also isolate critical analog paths from sources of high interference. High frequency circuits (analog and digital) should be separated from low frequency ones. Properly designed multilayer printed circuit boards can reduce EMI emission and increase immunity to RF field by a factor of 10 or more compared with double-sided boards. A multilayer board allows a complete layer to be used for ground plane, whereas the ground plane side of a doubleside board is often disrupted with signal crossover. If the system has separate analog and digital ground and power planes, the analog ground plane should be underneath the analog power plane, and, similarly, the digital ground plane should be underneath the digital power plane. There should be no overlap between analog and digital ground planes nor analog and digital power planes.

INPUT CAPACITOR SELECTION

The SSM2302 will not require input coupling capacitors if the input signal is biased from 1.0 V to $V_{\rm DD}-1.0$ V. Input capacitors are required if the input signal is not biased within this recommended input dc common-mode voltage range, if high-pass filtering is needed (Figure 20), or if using a single-ended source (Figure 21). If high-pass filtering is needed at the input, the input capacitor along with the input resistor of the SSM2302 will form a high-pass filter whose corner frequency is determined by the following equation:

$$f_C = 1/(2\pi \times R_{IN} \times C_{IN})$$

Input capacitor can have very important effects on the circuit performance. Not using input capacitors degrades the output offset of the amplifier as well as the PSRR performance.

PROPER POWER SUPPLY DECOUPLING

To ensure high efficiency, low total harmonic distortion (THD), and high PSRR, proper power supply decoupling is necessary. Noise transients on the power supply lines are short-duration voltage spikes. Although the actual switching frequency can range from 10 kHz to 100 kHz, these spikes can contain frequency components that extend into the hundreds of megahertz. The power supply input needs to be decoupled with a good quality low ESL and low ESR capacitor—usually around 4.7 μF . This capacitor bypasses low frequency noises to the ground plane. For high frequency transients noises, use a 0.1 μF capacitor as close as possible to the VDD pin of the device. Placing the decoupling capacitor as close as possible to the SSM2302 helps maintain efficiency performance.

EVALUATION BOARD INFORMATIONINTRODUCTION

The SSM2302 audio power amplifier is a complete low power, Class-D, stereo audio amplifier capable of delivering 1.4 W/channel into 8 Ω load. In addition to the minimal parts required for the application circuit, measurement filters are provided on the evaluation board so that conventional audio measurements can be made without additional components.

This section provides an overview of Analog Devices SSM2302 evaluation board. It includes a brief description of the board as well as a list of the board specifications.

Table 5. SSM2302 Evaluation Board Specifications

Parameter	Specification
Supply Voltage Range, VDD	2.5 V to 5.0 V
Power Supply Current Rating	1.5 A
Continuous Output Power, Po ($R_L = 8 \Omega$, $f = 1 \text{ kHz}$, 22 kHz BW)	1.4 W
Minimum Load Impedance	8Ω

OPERATION

Use the following steps when operating the SSM2302 evaluation board.

Power and Ground

 Set the power supply voltage between 2.5 V and 5.0 V. When connecting the power supply to the SSM2302 evaluation board, make sure to attach the ground connection to the GND header pin first and then connect the positive supply to the VDD header pin.

Inputs and Outputs

- 1. Ensure that the audio source is set to the minimum level.
- 2. Connect the audio source to Inputs INL± and INR±.
- 3. Connect the speakers to Outputs OUTL± and OUTR±.

Gain Control

The gain select header controls the gain setting of the SSM2302.

- 1. Select jumper to LG for 6 dB gain.
- 2. Select jumper to HG for 12 dB gain.

External Gain Settings

It is possible to adjust the SSM2302 gain using external resistors at the input. To set a gain lower than 12 dB refer to Figure 22 and Figure 23 on the product data sheet for proper circuit configuration. For external gain configuration from a fixed 12 dB gain, use the following formula:

External Gain Settings = $20 \log[4/(1 + R/150 k\Omega)]$

To set a gain lower than 6 dB refer to Figure 24 and Figure 25 on the product data sheet for proper circuit configuration. For external gain configuration from a fixed 6 dB gain, use the following formula:

External Gain Settings = $20 \log[2/(1 + R/150 k\Omega)]$

Shutdown Control

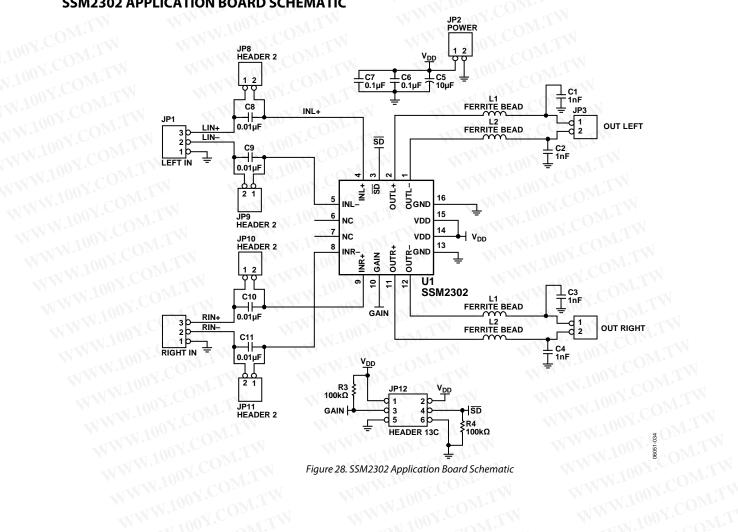
The shutdown select header controls the shutdown function of the SSM2302. The shutdown pin on the SSM2302 is active low, meaning that a low voltage (GND) on this pin places the SSM2302 into shutdown mode.

- 1. Select jumper to 1-2 position. Shutdown pulled to V_{DD}.
- 2. Select jumper to 2-3 position. Shutdown pulled to GND.

Input Configurations

- 1. For differential input configuration with input capacitors do not place a jumper on JP8, JP9, JP10, and JP11.
- 2. For differential input configuration without input capacitors place a jumper on JP8, JP9, JP10, and JP11.

SSM2302 APPLICATION BOARD SCHEMATIC



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Figure 28. SSM2302 Application Board Schematic WWW.100Y.CO1

SSM2302 STEREO CLASS-D AMPLIFIER EVALUATION MODULE COMPONENT LIST Table 6.

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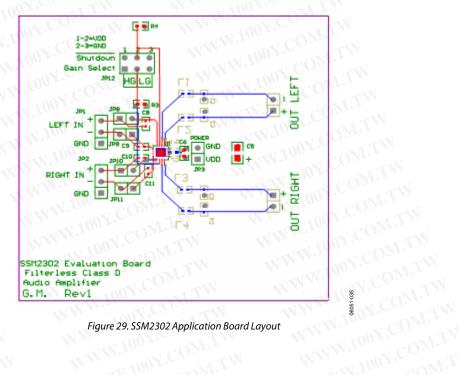
Reference	Description	Footprint	Quantity	Manufacturer/Part Number
C8, C9, C10, C11	Capacitors, 0.01 μF	0402	4	Murata Manufacturing Co., Ltd./GRM15
C6, C7	Capacitor, 0.1 µF	0603	2	Murata Manufacturing Co., Ltd./GRM18
C5 COM	Capacitor, 10 μF	0805	1	Murata Manufacturing Co., Ltd./GRM21
C1, C2, C3, C4	Capacitor, 1 nF	0402	4	Murata Manufacturing Co., Ltd./GRM15
R3, R4	Resistor, 100 kΩ	0603	2	Vishay/CRCW06031003F
L1, L2, L3, L4	Ferrite bead	0402	4	Murata Manufacturing Co., Ltd./BLM15EG12
U1 COM	IC, SSM2302	3.0 mm × 3.0 mm	1 1 N	SSM2302CSPZ
EVAL BOARD	PCB evaluation board	1001.	1	100 M. M. T.

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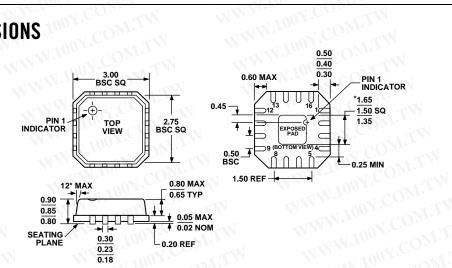
SSM2302 APPLICATION BOARD LAYOUT



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Figure 29. SSM2302 Application Board Layout

OUTLINE DIMENSIONS



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*COMPLIANT TO JEDEC STANDARDS MO-220-VEED-2 EXCEPT FOR EXPOSED PAD DIMENSION.

WWW.100Y.COM.TW WWW.100Y.COM.TW Figure 30. 16-Lead Lead Frame Chip Scale Package [LFCSP_VQ] 3 mm × 3 mm Body, Very Thin Quad (CP-16-3)Dimensions shown in millimeters

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Model	Temperature Range	Package Description	Package Option	Branding
SSM2302CPZ-R2 ¹	−40°C to +85°C	16-Lead Lead Frame Chip Scale Package [LFCSP_VQ]	CP-16-3	A15
SSM2302CPZ-REEL ¹	-40°C to +85°C	16-Lead Lead Frame Chip Scale Package [LFCSP_VQ]	CP-16-3	A15
SSM2302CPZ-REEL7 ¹	-40°C to +85°C	16-Lead Lead Frame Chip Scale Package [LFCSP_VQ]	CP-16-3	A15

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